## **AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the present application.

## **LISTING OF CLAIMS:**

Claims 1 to 8. (Canceled).

9. (Currently Amended) A method for coating a substrate, comprising: one of (a) external currentless and (b) electrolytic deposition of at least one of (a) Ni, (b) Co and (c) Pt in a deposition bath in which particles including at least one of (a) Mg, (b) Al, (c) Ti[[,]] and (d) Zn, and (e) no not including Cr, are suspended, the particles becoming occluded in the coating; and

heat treating the coated substrate.

- 10. (Previously Presented) The method according to claim 9, wherein the particles include an oxide layer thicker than an oxide layer developed under normal environmental conditions.
- 11. (Previously Presented) The method according to claim 9, wherein the particles are alloyed with at least one of (a) Ni, (b) Co and (c) Pt.
- 12. (Previously Presented) The method according to claim 9, wherein the deposition bath includes suspended silicon particles, the silicon particles becoming occluded in the coating.
- 13. (Previously Presented) The method according to claim 9, wherein the particles are alloyed with Si.
- 14. (Previously Presented) The method according to claim 9, wherein a diameter of the particles is 1 to 50  $\mu m$ .
- 15. (Previously Presented) The method according to claim 9, wherein the coating is deposited to a thickness of 10 to 100  $\mu$ m.

Claims 16 to 22. (Canceled).

NY01 1532571 3